



SGM2045LC

300mA, Low V_{IN} , Ultra-Low Noise, Low Start-Up Current, High PSRR Linear Regulator

GENERAL DESCRIPTION

The SGM2045LC is an ultra-low noise, low V_{IN} , high PSRR and low dropout voltage linear regulator. It is capable of supplying 300mA output current with typical dropout voltage of only 50mV. The operating input voltage range is from 1.1V to 5.5V and output voltage range is from 0.6V to 4.2V.

Other features include logic-controlled shutdown mode and thermal shutdown protection. The SGM2045LC has automatic discharge function to quickly discharge V_{OUT} in the disabled status.

The SGM2045LC is suitable for applications which need low noise and fast transient response power supply, such as power supply of camera module in smart phone, etc.

The SGM2045LC is available in Green XTDFN-1×1-4L and WLCSP-0.64×0.64-4B-A packages. It operates over an operating temperature range of -40°C to +125°C.

APPLICATIONS

Portable Electronic Devices

Smoke Detectors

IP Cameras

Wireless LAN Devices

Battery-Powered Equipment

Smartphones and Tablets

Digital Cameras and Audio Devices

TYPICAL APPLICATION

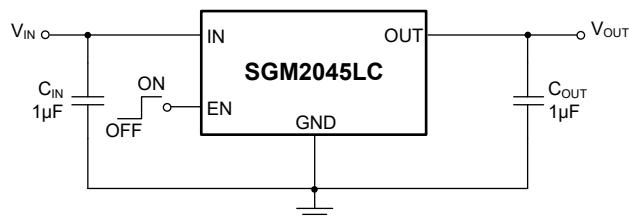


Figure 1. Typical Application Circuit

SGM2045LC

**300mA, Low V_{IN}, Ultra-Low Noise,
Low Start-Up Current, High PSRR Linear Regulator**

PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM2045LC-0.6	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-0.6XXDH4G/TR	44	Tape and Reel, 10000
SGM2045LC-0.7	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-0.7XXDH4G/TR	41	Tape and Reel, 10000
SGM2045LC-0.75	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-0.75XXDH4G/TR	45	Tape and Reel, 10000
SGM2045LC-0.8	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-0.8XXDH4G/TR	46	Tape and Reel, 10000
SGM2045LC-0.85	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-0.85XXDH4G/TR	47	Tape and Reel, 10000
SGM2045LC-1.0	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-1.0XXDH4G/TR	48	Tape and Reel, 10000
SGM2045LC-1.05	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-1.05XXDH4G/TR	49	Tape and Reel, 10000
SGM2045LC-1.1	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-1.1XXDH4G/TR	4A	Tape and Reel, 10000
SGM2045LC-1.2	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-1.2XXDH4G/TR	4V	Tape and Reel, 10000
SGM2045LC-1.25	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-1.25XXDH4G/TR	5S	Tape and Reel, 10000
SGM2045LC-1.3	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-1.3XXDH4G/TR	42	Tape and Reel, 10000
SGM2045LC-1.5	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-1.5XXDH4G/TR	4B	Tape and Reel, 10000
SGM2045LC-1.6	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-1.6XXDH4G/TR	43	Tape and Reel, 10000
SGM2045LC-1.8	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-1.8XXDH4G/TR	2X	Tape and Reel, 10000
SGM2045LC-1.825	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-1.825XXDH4G/TR	4E	Tape and Reel, 10000
SGM2045LC-2.2	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-2.2XXDH4G/TR	4F	Tape and Reel, 10000
SGM2045LC-2.5	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-2.5XXDH4G/TR	40	Tape and Reel, 10000
SGM2045LC-2.8	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-2.8XXDH4G/TR	2Y	Tape and Reel, 10000
SGM2045LC-2.9	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-2.9XXDH4G/TR	4L	Tape and Reel, 10000
SGM2045LC-3.0	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-3.0XXDH4G/TR	4M	Tape and Reel, 10000
SGM2045LC-3.3	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-3.3XXDH4G/TR	4N	Tape and Reel, 10000
SGM2045LC-4.2	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-4.2XXDH4G/TR	4O	Tape and Reel, 10000

PACKAGE/ORDERING INFORMATION (continued)

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM2045LC-0.6	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-0.6XG/TR	09	Tape and Reel, 5000
SGM2045LC-0.8	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-0.8XG/TR	0A	Tape and Reel, 5000
SGM2045LC-0.85	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-0.85XG/TR	05	Tape and Reel, 5000
SGM2045LC-1.0	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-1.0XG/TR	06	Tape and Reel, 5000
SGM2045LC-1.05	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-1.05XG/TR	0B	Tape and Reel, 5000
SGM2045LC-1.1	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-1.1XG/TR	0C	Tape and Reel, 5000
SGM2045LC-1.15	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-1.15XG/TR	0Q	Tape and Reel, 5000
SGM2045LC-1.2	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-1.2XG/TR	03	Tape and Reel, 5000
SGM2045LC-1.3	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-1.3XG/TR	0D	Tape and Reel, 5000
SGM2045LC-1.6	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-1.6XG/TR	08	Tape and Reel, 5000
SGM2045LC-1.75	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-1.75XG/TR	0E	Tape and Reel, 5000
SGM2045LC-1.8	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-1.8XG/TR	0F	Tape and Reel, 5000
SGM2045LC-1.825	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-1.825XG/TR	0G	Tape and Reel, 5000
SGM2045LC-2.2	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-2.2XG/TR	0H	Tape and Reel, 5000
SGM2045LC-2.5	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-2.5XG/TR	07	Tape and Reel, 5000
SGM2045LC-2.8	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-2.8XG/TR	04	Tape and Reel, 5000
SGM2045LC-2.9	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-2.9XG/TR	0I	Tape and Reel, 5000
SGM2045LC-3.0	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-3.0XG/TR	0J	Tape and Reel, 5000
SGM2045LC-3.3	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-3.3XG/TR	0K	Tape and Reel, 5000
SGM2045LC-4.2	WLCSP-0.64×0.64-4B-A	-40°C to +125°C	SGM2045LC-4.2XG/TR	0L	Tape and Reel, 5000

MARKING INFORMATION

YY

Serial Number

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

IN to GND	-0.3V to 6V
EN to GND	-0.3V to 6V
OUT to GND	-0.3V to (V_{IN} + 0.3V)
Package Thermal Resistance	
XTDFN-1×1-4L, θ_{JA}	167.6°C/W
XTDFN-1×1-4L, θ_{JB}	103.4°C/W
XTDFN-1×1-4L, $\theta_{JC(TOP)}$	128.7°C/W
XTDFN-1×1-4L, $\theta_{JC(BOT)}$	98°C/W
WLCSP-0.64×0.64-4B-A, θ_{JA}	238.4°C/W
WLCSP-0.64×0.64-4B-A, θ_{JB}	122.9°C/W
WLCSP-0.64×0.64-4B-A, θ_{JC}	112.7°C/W
Junction Temperature.....	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10s).....	+260°C
ESD Susceptibility ⁽¹⁾⁽²⁾	
HBM.....	±8000V
CDM	±1000V

NOTES:

1. For human body model (HBM), all pins comply with ANSI/ESDA/JEDEC JS-001 specifications.
2. For charged device model (CDM), all pins comply with ANSI/ESDA/JEDEC JS-002 specifications.

RECOMMENDED OPERATING CONDITIONS

Input Voltage Range	1.1V to 5.5V
Enable Input Voltage Range	0V to 5.5V
Input Effective Capacitance, C_{IN}	0.1μF (MIN)
Output Effective Capacitance, C_{OUT}	0.5μF to 200μF ⁽¹⁾
Operating Junction Temperature Range.....	-40°C to +125°C

NOTE:

1. To maintain a 100μA minimum output current when the output effective capacitance is more than 10μF.

OVERSTRESS CAUTION

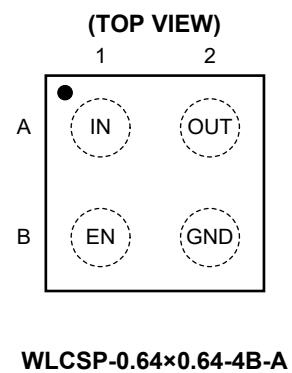
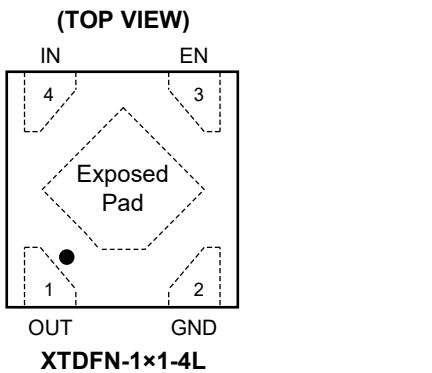
Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATIONS**PIN DESCRIPTION**

PIN		NAME	FUNCTION
XTDFN-1x1-4L	WLCSP-0.64x0.64-4B-A		
1	A2	OUT	Regulator Output Pin. It is recommended to use a ceramic capacitor with effective capacitance in the range of 0.5µF to 200µF to ensure stability. This ceramic capacitor should be placed as close as possible to OUT pin.
2	B2	GND	Ground.
3	B1	EN	Enable Pin. Drive EN high to turn on the regulator. Drive EN low to turn off the regulator. The EN pin has an internal 0.03µA pull-down current source. This pin must be connected to IN pin if enable functionality is not used.
4	A1	IN	Input Supply Voltage Pin. It is recommended to use a 1µF or larger ceramic capacitor from IN pin to ground to get good power supply decoupling. This ceramic capacitor should be placed as close as possible to IN pin.
Exposed Pad	—	—	Exposed Pad. Connect it to a large ground plane to maximize thermal performance; this pad is not an electrical connection point.

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FUNCTIONAL BLOCK DIAGRAM

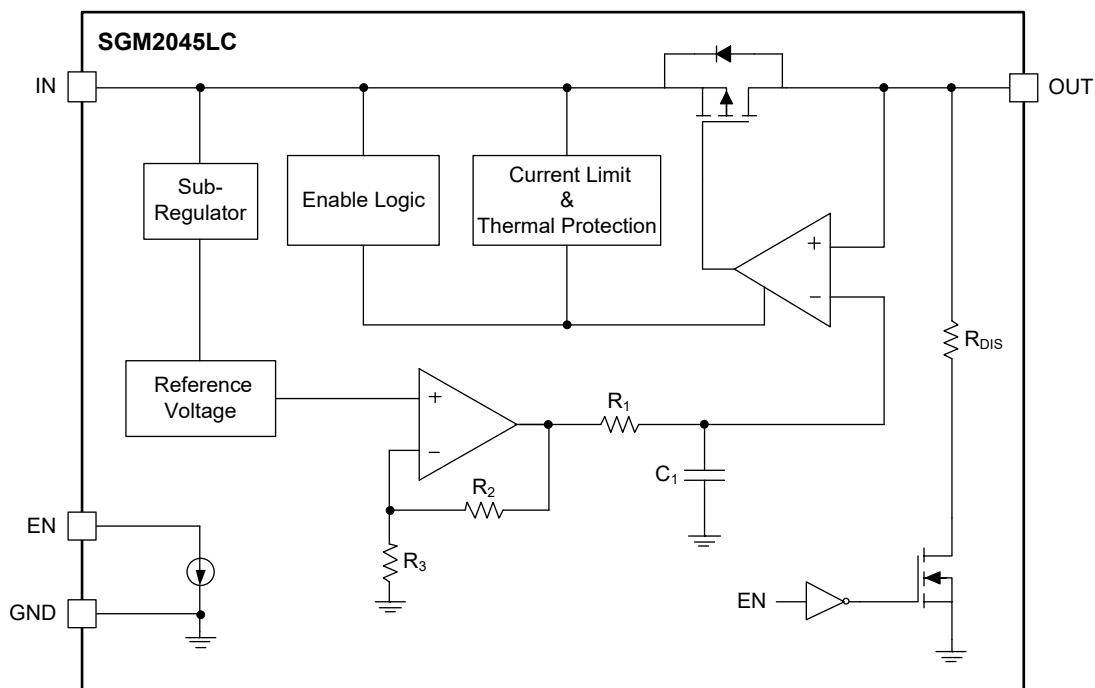


Figure 2. Block Diagram

ELECTRICAL CHARACTERISTICS

($V_{IN} = V_{OUT(NOM)} + 0.3V$, $V_{EN} = V_{IN}$, $C_{IN} = 1\mu F$, $C_{OUT} = 1\mu F$, $T_J = -40^\circ C$ to $+125^\circ C$, typical values are at $T_J = +25^\circ C$, unless otherwise noted.)

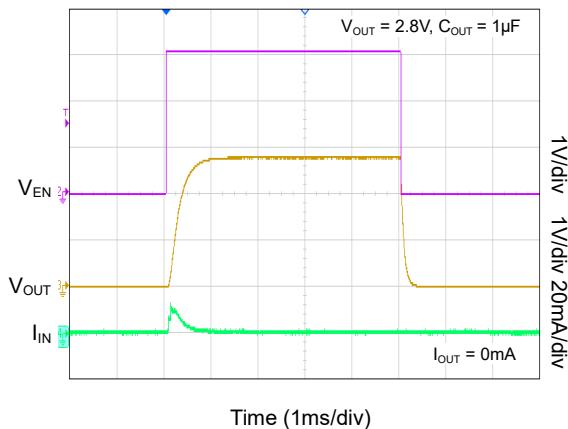
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Voltage Range	V_{IN}	$I_{OUT} = 60mA$	1.1		5.5	V
		$I_{OUT} = 100mA$	1.2		5.5	
		$I_{OUT} = 200mA$	1.3		5.5	
		$I_{OUT} = 300mA$	1.4		5.5	
Output Voltage Accuracy	V_{OUT}	$I_{OUT} = 0.1mA$, $T_J = +25^\circ C$	-1		1	%
		$I_{OUT} = 0.1mA$ to $300mA$, $V_{IN} = (V_{OUT(NOM)} + 0.3V)$ to $5.5V$, $T_J = -40^\circ C$ to $+125^\circ C$	-2.5		2.5	
Line Regulation	ΔV_{OUT_LNR}	$V_{IN} = (V_{OUT(NOM)} + 0.3V)$ to $5.5V$, $I_{OUT} = 0.1mA$		0.05	2.5	mV
Load Regulation	ΔV_{OUT_LDR}	$I_{OUT} = 0.1mA$ to $300mA$		0.4	10	mV
Dropout Voltage ⁽¹⁾	V_{DROP}	$I_{OUT} = 300mA$	$1.05V \leq V_{OUT(NOM)} < 1.2V$	260	360	mV
			$1.2V \leq V_{OUT(NOM)} < 1.5V$	185	300	
			$1.5V \leq V_{OUT(NOM)} < 1.8V$	125	220	
		$I_{OUT} = 300mA$, XTDFN-1x1-4L	$1.8V \leq V_{OUT(NOM)} < 2.8V$	100	190	
			$2.8V \leq V_{OUT(NOM)} \leq 4.2V$	70	150	
		$I_{OUT} = 300mA$, WLCSP-0.64x0.64-4B-A	$1.8V \leq V_{OUT(NOM)} < 2.8V$	80	130	
			$2.8V \leq V_{OUT(NOM)} \leq 4.2V$	50	120	
Output Current Limit	I_{LIMIT}	$V_{OUT} = 90\% \times V_{OUT(NOM)}$, $V_{IN} = V_{OUT(NOM)} + 0.3V$	$T_J = -20^\circ C$ to $+125^\circ C$	300	600	mA
			$T_J = -40^\circ C$ to $+125^\circ C$	260	600	
Short-Circuit Current	I_{SHORT}	$V_{OUT} = 0V$		380		mA
Quiescent Current	I_Q	$I_{OUT} = 0mA$		15	40	µA
Shutdown Supply Current	I_{SHDN}	$V_{EN} = 0V$, $V_{IN} = 5.5V$		0.03	2	µA
EN Pin High-Level Input Voltage	V_{IH}	$V_{IN} = 1.1V$ to $5.5V$, EN input voltage "H"	0.7		5.5	V
EN Pin Low-Level Input Voltage	V_{IL}	$V_{IN} = 1.1V$ to $5.5V$, EN input voltage "L"	0		0.3	V
EN Pull-Down Current	I_{EN}	$V_{EN} = 5.5V$, $V_{IN} = 5.5V$		0.03	1	µA
Output Discharge Resistance	R_{DIS}	$V_{EN} = 0V$, $V_{OUT} = 0.2V$, $V_{IN} = 3.3V$		60		Ω
Turn-On Time	t_{ON}	From EN rising from $0V$ to V_{IN} to $90\% \times V_{OUT(NOM)}$, no load, $V_{OUT(NOM)} = 2.8V$		500	1200	µs
Power Supply Rejection Ratio	PSRR	$I_{OUT} = 20mA$, $V_{OUT(NOM)} = 1.8V$, $V_{IN} = 2.8V$	$f = 100Hz$	86		dB
			$f = 1kHz$	88		
			$f = 10kHz$	81		
			$f = 100kHz$	50		
Output Voltage Noise	e_n	$f = 10Hz$ to $100kHz$, $I_{OUT} = 20mA$, $V_{OUT(NOM)} = 2.8V$		11		µV _{RMS}
Thermal Shutdown Temperature	T_{SHDN}	T_J rising		160		°C
Thermal Shutdown Hysteresis	ΔT_{SHDN}	Hysteresis		20		°C

NOTE:

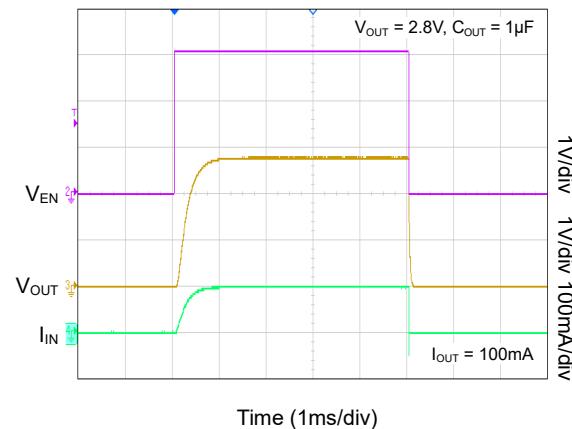
- The dropout voltage is defined as the difference between V_{IN} and V_{OUT} when V_{OUT} falls to $(V_{OUT(NOM)} - 50mV)$.

SGM2045LC**300mA, Low V_{IN} , Ultra-Low Noise,
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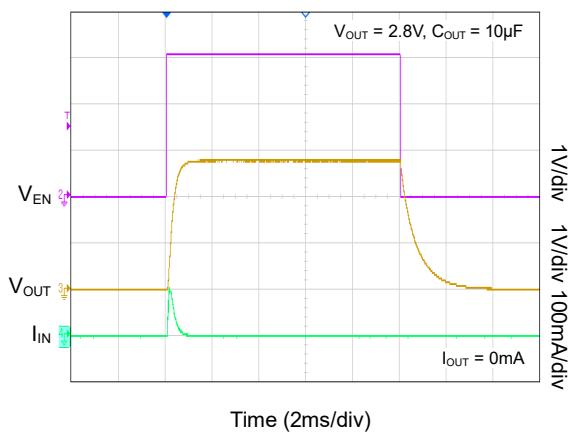
Enable Turn-On Response



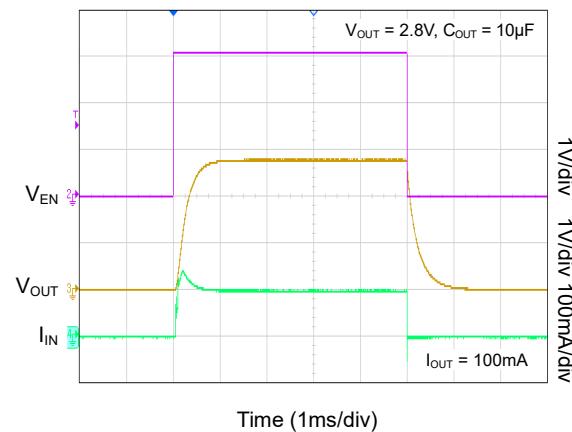
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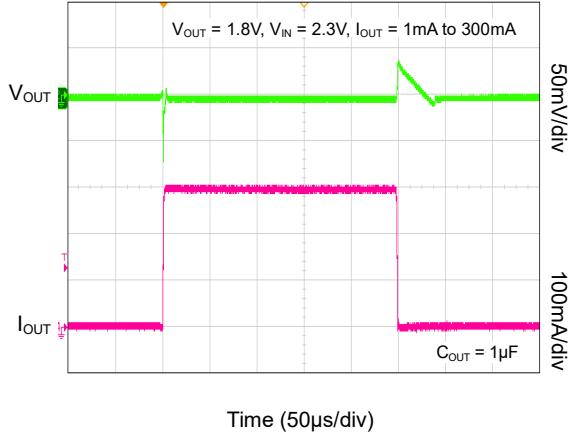
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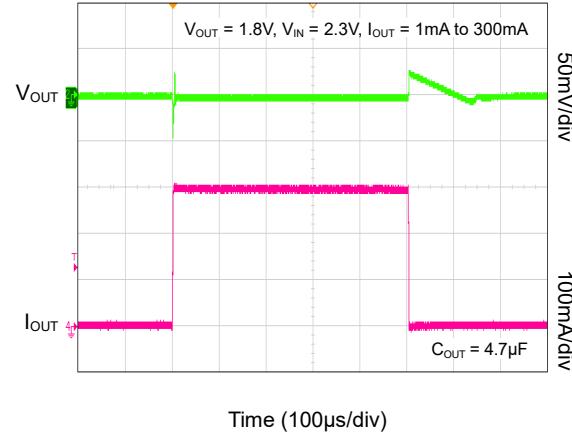
Enable Turn-On Response



Load Transient Response

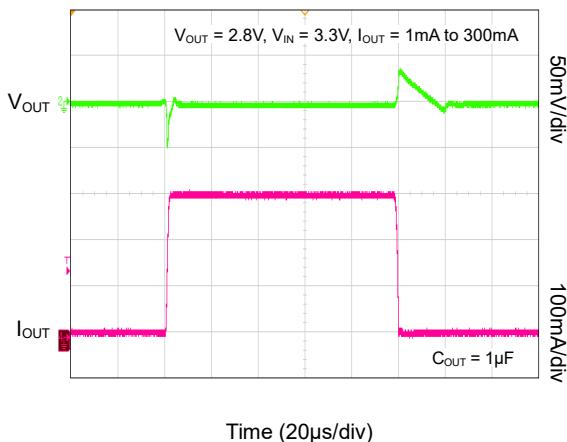


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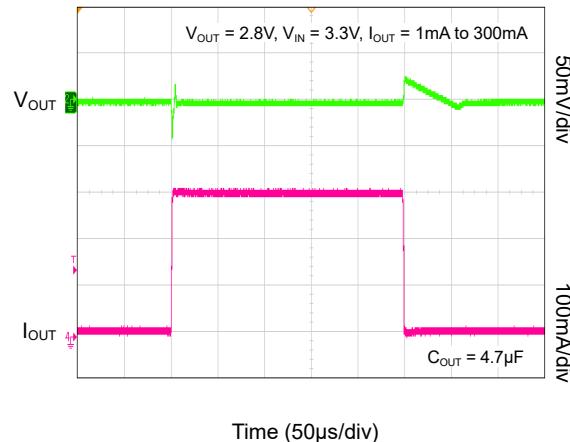


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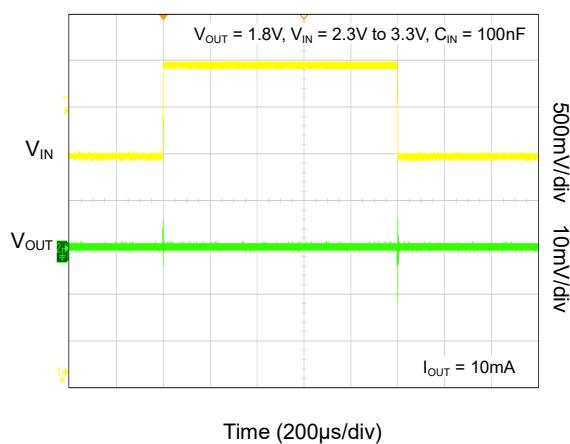
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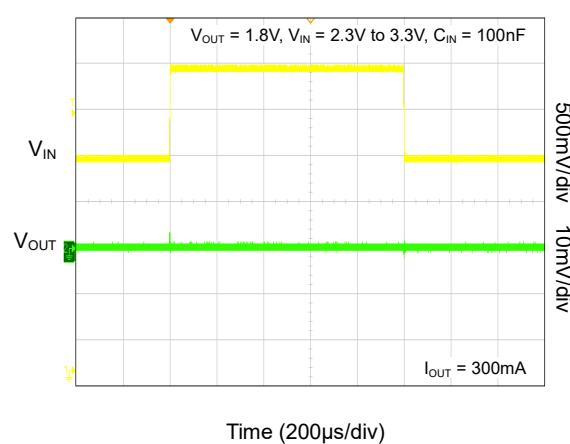
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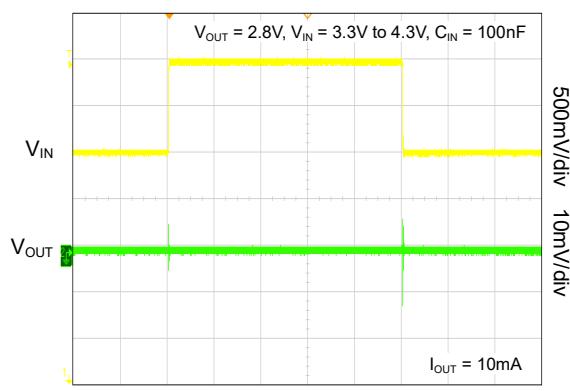
Line Transient Response



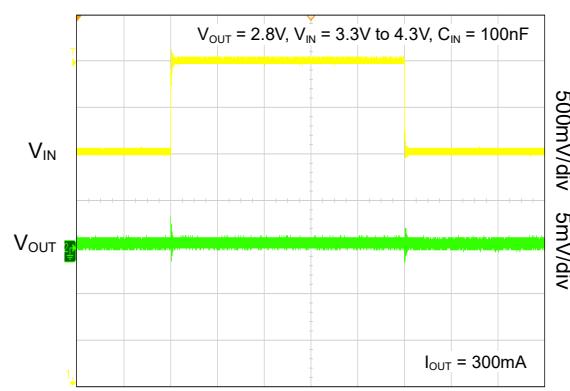
Line Transient Response



Line Transient Response

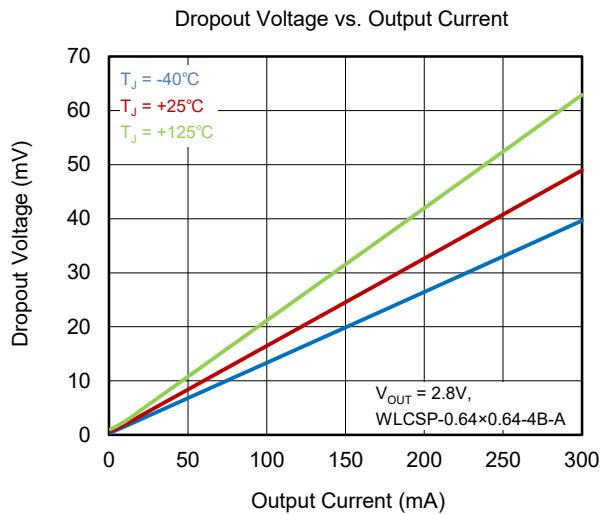
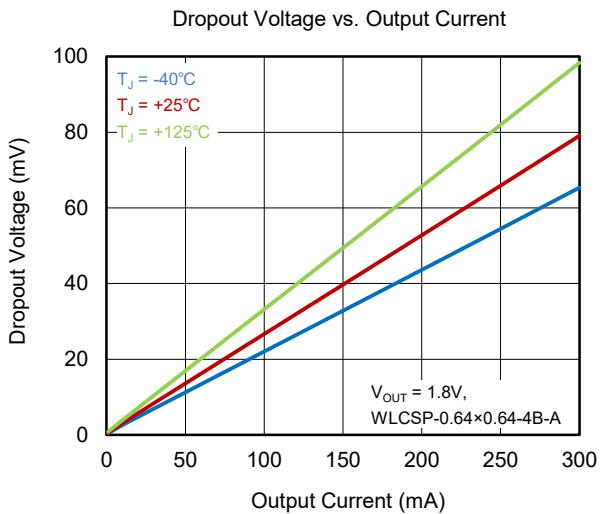
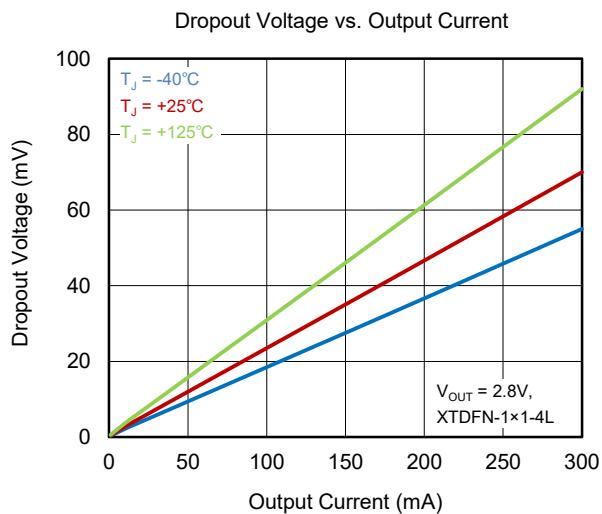
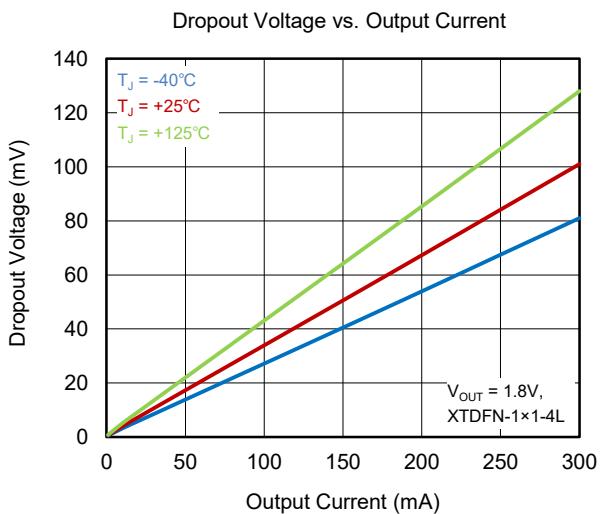
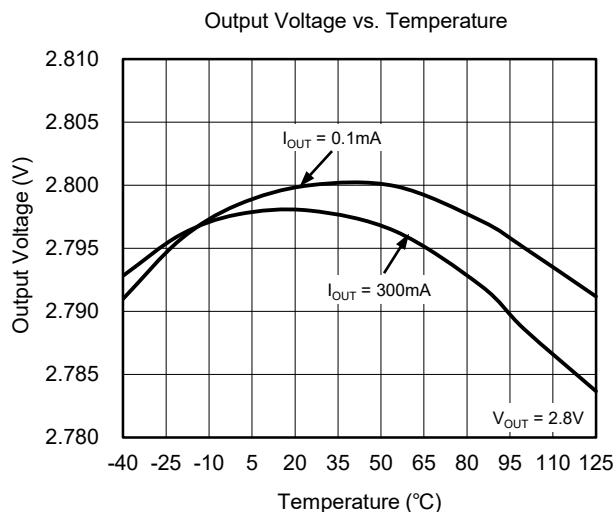
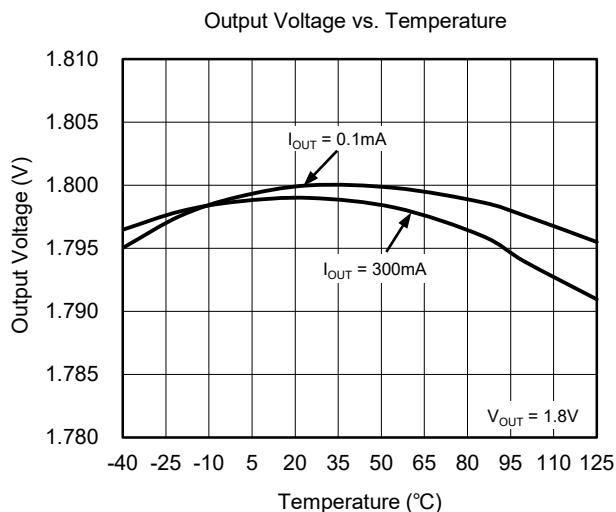


Line Transient Response



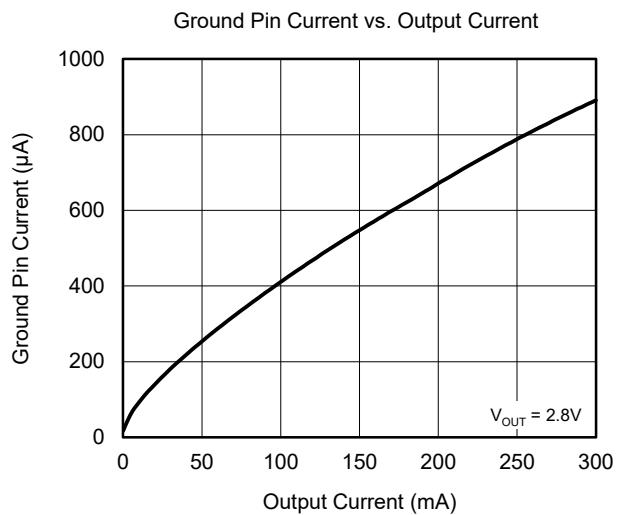
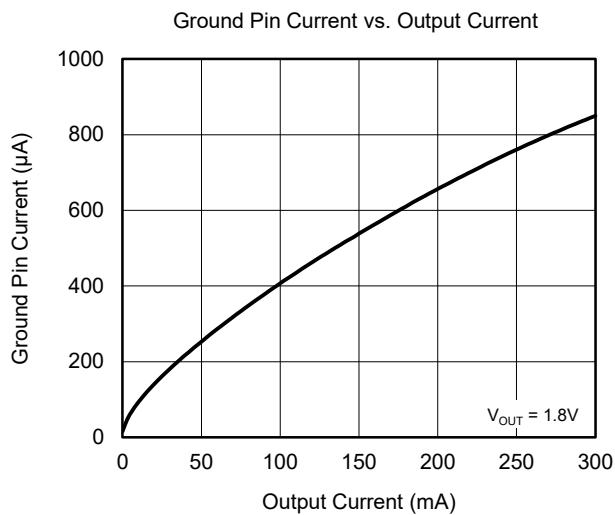
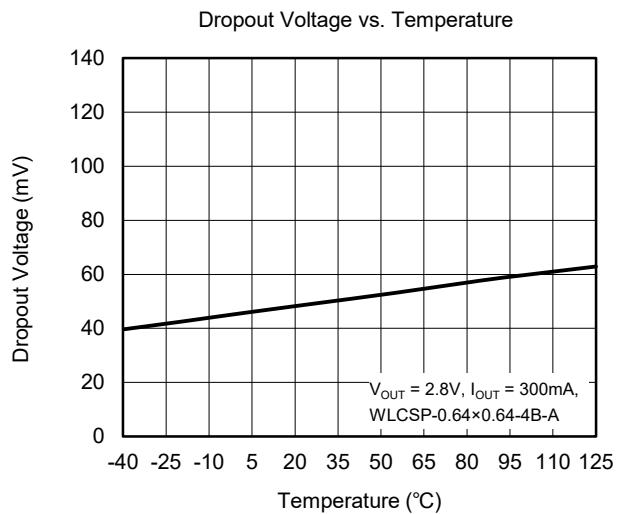
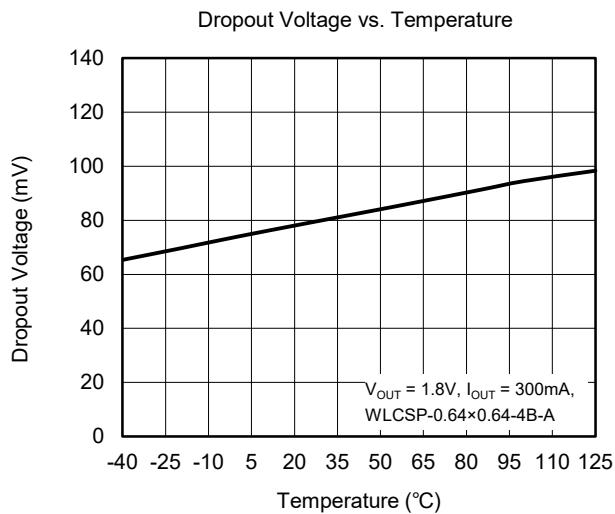
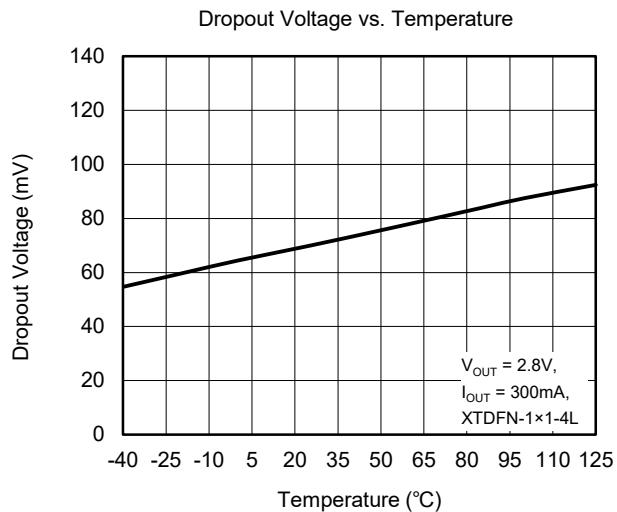
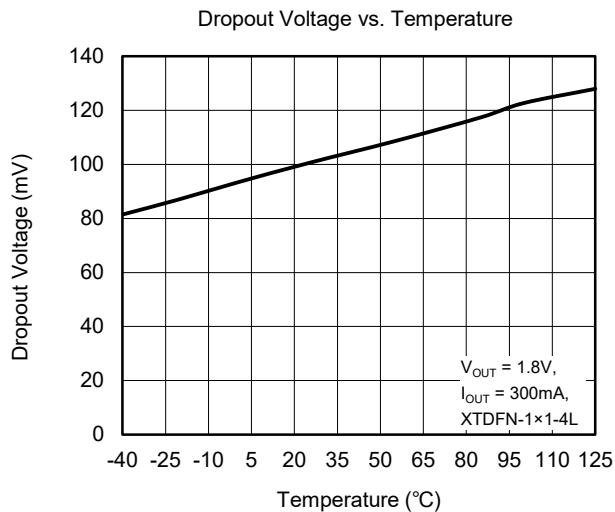
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

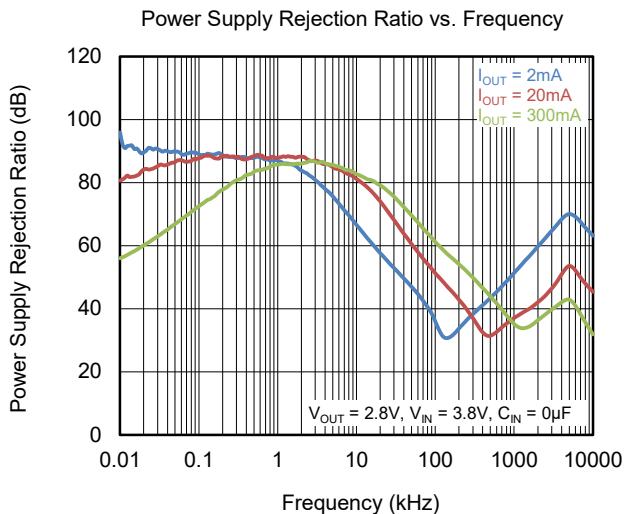
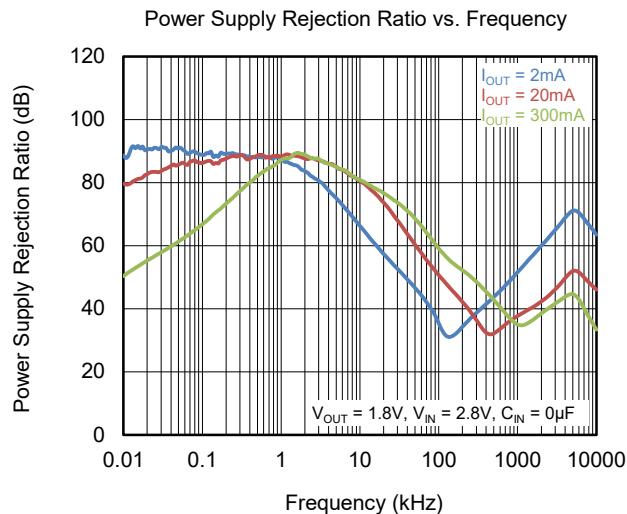
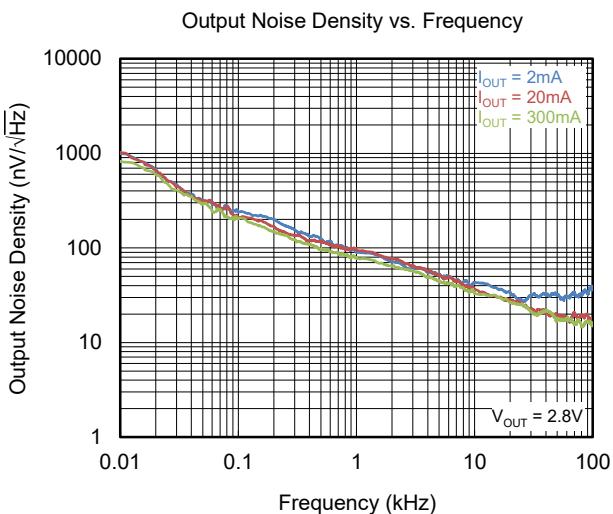
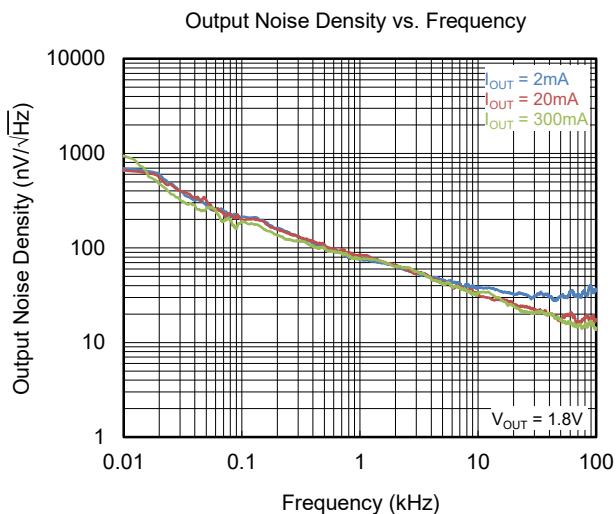
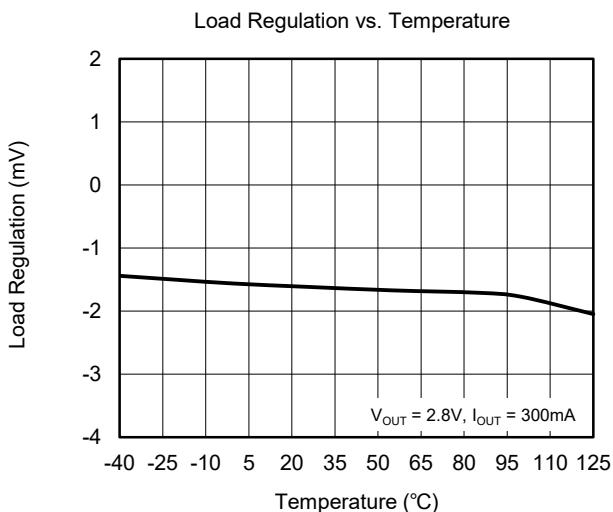
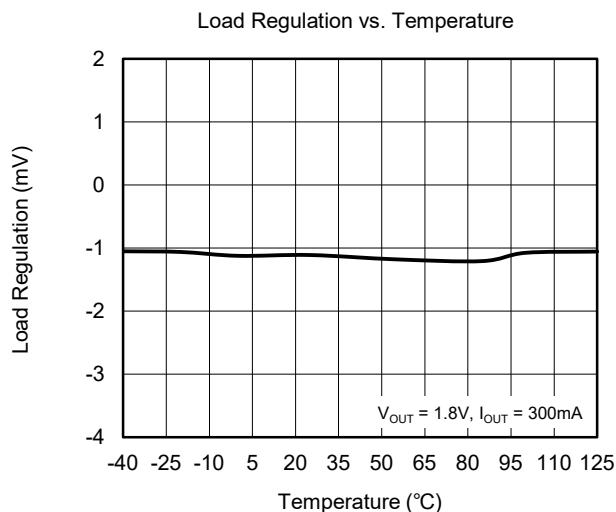
$T_J = +25^\circ\text{C}$, $V_{IN} = V_{OUT(\text{NOM})} + 0.3\text{V}$, $V_{EN} = V_{IN}$, $C_{IN} = 1\mu\text{F}$, $C_{OUT} = 1\mu\text{F}$, unless otherwise noted.



SGM2045LC**300mA, Low V_{IN} , Ultra-Low Noise,
Low Start-Up Current, High PSRR Linear Regulator****TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

$T_J = +25^\circ\text{C}$, $V_{IN} = V_{OUT(\text{NOM})} + 0.3\text{V}$, $V_{EN} = V_{IN}$, $C_{IN} = 1\mu\text{F}$, $C_{OUT} = 1\mu\text{F}$, unless otherwise noted.



SGM2045LC**300mA, Low V_{IN} , Ultra-Low Noise,
Low Start-Up Current, High PSRR Linear Regulator****TYPICAL PERFORMANCE CHARACTERISTICS (continued)** $T_J = +25^\circ\text{C}$, $V_{IN} = V_{OUT(NOM)} + 0.3\text{V}$, $V_{EN} = V_{IN}$, $C_{IN} = 1\mu\text{F}$, $C_{OUT} = 1\mu\text{F}$, unless otherwise noted.

APPLICATION INFORMATION

The SGM2045LC is a low V_{IN} , ultra-low noise and low dropout LDO and provides 300mA output current. These features make the device a reliable solution to solve many challenging problems in the generation of clean and accurate power supply. The high performance also makes the SGM2045LC useful in a variety of applications. The SGM2045LC provides the protection functions for output overload and overheating.

The SGM2045LC provides an EN pin as an external chip enable control to enable/disable the device. When the regulator is in shutdown state, the shutdown current consumes as low as 0.03 μ A (TYP).

Input Capacitor Selection (C_{IN})

The input decoupling capacitor should be placed as close as possible to the IN pin for ensuring the device stability. 1 μ F or larger X7R or X5R ceramic capacitor is selected to get good dynamic performance.

When V_{IN} is required to provide large current instantaneously, a large effective input capacitor is required. Multiple input capacitors can limit the input tracking inductance. Adding more input capacitors is available to restrict the ringing and to keep it below the device absolute maximum ratings.

Output Capacitor Selection (C_{OUT})

One or more output capacitors are required to maintain the stability of the LDO, and the output capacitors should be placed as close as possible to the OUT pin. In addition, in order to obtain the best transient performance, it is recommended to use X7R and X5R ceramic capacitors as output capacitors. Ceramic capacitors have low equivalent series resistance (ESR), excellent temperature and DC bias characteristics. However, it cannot be ignored that the effective capacitance of ceramic capacitors is affected by temperature, DC bias and package size.

For example, Figure 3 shows the capacitance and DC bias and temperature characteristics of 0805, 10V, 10 μ F \pm 10%, X7R capacitor. Therefore, it is necessary to evaluate whether the effective capacitance of the output capacitor can meet the stability requirements of the LDO in practical applications. In general, a capacitor in higher voltage rating and a larger package

exhibits better stability, and the effective capacitance can be obtained from the manufacturer datasheet.

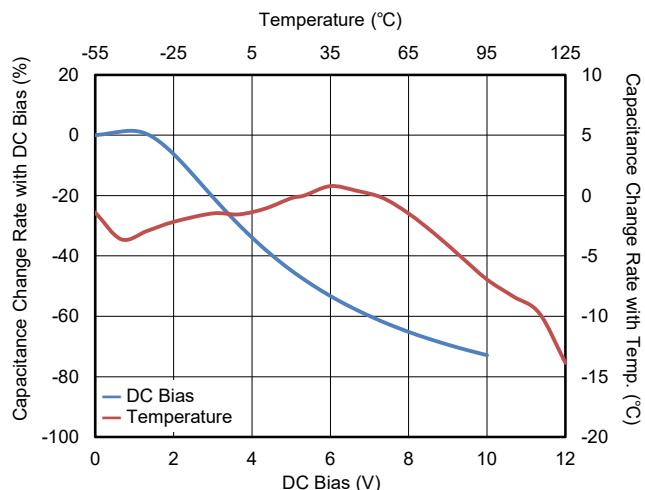


Figure 3. Capacitance vs. DC Bias and Temperature Characteristics

The SGM2045LC requires a minimum effective capacitance of 0.5 μ F for C_{OUT} to ensure stability. Additionally, C_{OUT} with larger capacitance and lower ESR will help increase the high frequency PSRR and improve the load transient response.

Enable Operation

The EN pin of the SGM2045LC is used to enable/disable its device and to deactivate/activate the output automatic discharge function.

When the EN pin voltage is lower than 0.3V, the device is in shutdown state. There is no current flowing from IN to OUT pins. In this state, the automatic discharge transistor is active to discharge the output voltage through a 60 Ω (TYP) resistor.

When the EN pin voltage is higher than 0.7V, the device is in active state. The output voltage is regulated to the expected value and the automatic discharge transistor is turned off.

The EN pin is pulled down by internal 0.03 μ A (TYP) current source when the EN pin is floated. This current source will ensure the SGM2045LC in shutdown state and reduce the power dissipation in system.

APPLICATION INFORMATION (continued)

Negatively Biased Output

When the output voltage is negative, the chip may not start up due to parasitic effects. Ensure that the output is greater than -0.3V under all conditions. If negatively biased output is excessive and expected in the application, a Schottky diode can be added between the OUT pin and GND pin.

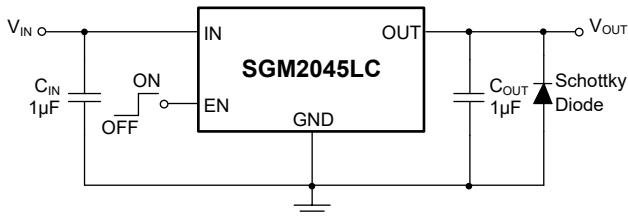


Figure 4. Negatively Biased Output Application

Output Current Limit Protection

When overload events happen, the output current is internally limited to 600mA (TYP). When the OUT pin is shorted to ground, the output current is internally limited to 380mA (TYP).

Thermal Shutdown

The SGM2045LC can detect the temperature of die. When the die temperature exceeds the threshold value

of thermal shutdown, the SGM2045LC will be in shutdown state and it will remain in this state until the die temperature decreases to +140°C.

Power Dissipation (P_D)

Power dissipation (P_D) of the SGM2045LC can be calculated by the equation $P_D = (V_{IN} - V_{OUT}) \times I_{OUT}$. The maximum allowable power dissipation ($P_{D(MAX)}$) of the SGM2045LC is affected by many factors, including the difference between junction temperature and ambient temperature ($T_{J(MAX)} - T_A$), package thermal resistance from the junction to the ambient environment (θ_{JA}), the rate of ambient airflow and PCB layout. $P_{D(MAX)}$ can be approximated by the following equation:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A)/\theta_{JA} \quad (1)$$

Layout Guidelines

To get good PSRR, low output noise and high transient response performance, the input and output bypass capacitors must be placed as close as possible to the IN pin and OUT pin separately.

REVISION HISTORY

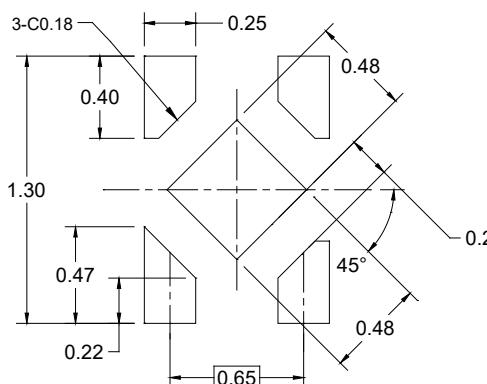
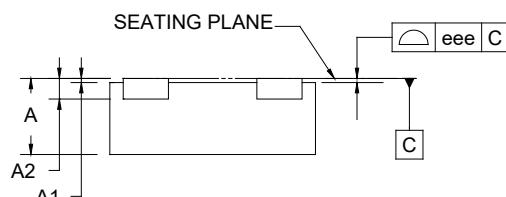
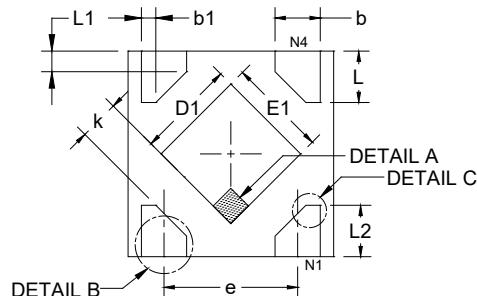
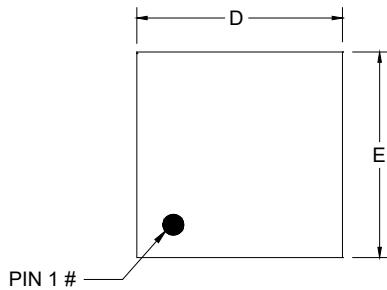
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

	Page
JULY 2025 – REV.B.1 to REV.B.2	
Added SGM2045LC-1.15XG/TR to Package/Ordering Information section	3
MAY 2025 – REV.B to REV.B.1	
Added SGM2045LC-1.25XXDH4G/TR to Package/Ordering Information section.....	2
APRIL 2025 – REV.A.4 to REV.B	
Added WL CSP-0.64×0.64-4B-A package	All
Updated Package/Ordering Information section.....	2, 3
Updated Electrical Characteristics section	7
Updated Typical Performance Characteristics section	10, 11
AUGUST 2022 – REV.A.3 to REV.A.4	
Updated Recommended Operating Conditions section.....	2
DECEMBER 2021 – REV.A.2 to REV.A.3	
Updated Typical Performance Characteristics section	5, 6
OCTOBER 2021 – REV.A.1 to REV.A.2	
Updated Package/Ordering Information section.....	2
OCTOBER 2021 – REV.A to REV.A.1	
Updated Electrical Characteristics section	4
Changes from Original (SEPTEMBER 2021) to REV.A	
Changed from product preview to production data	All

PACKAGE INFORMATION

PACKAGE OUTLINE DIMENSIONS

XTDFN-1x1-4L



ALTERNATE A-1 ALTERNATE A-2 ALTERNATE B-1 ALTERNATE B-2 ALTERNATE C-1 ALTERNATE C-2
DETAIL A
 ALTERNATE PIN 1 CONSTRUCTION
DETAIL B
 ALTERNATE TERMINAL CONSTRUCTION
DETAIL C
 ALTERNATE TERMINAL CONSTRUCTION

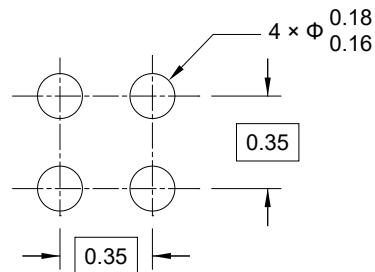
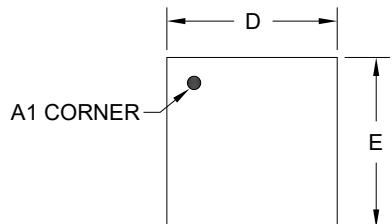
Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	0.340	0.370	0.400
A1	0.000	0.020	0.050
A2		0.100 REF	
b	0.170	-	0.300
b1		0.068 REF	
D	0.950	1.000	1.050
E	0.950	1.000	1.050
D1	0.430	0.480	0.530
E1	0.430	0.480	0.530
L	0.200	0.250	0.300
L1		0.093 REF	
L2	0.200	-	0.370
e		0.650 BSC	
k	0.150	-	-
eee	-	0.050	-

NOTE: This drawing is subject to change without notice.

PACKAGE INFORMATION

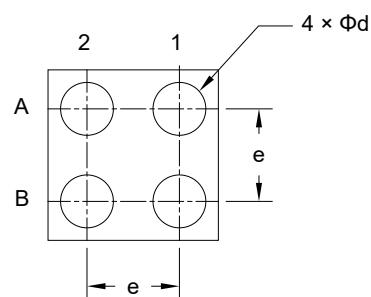
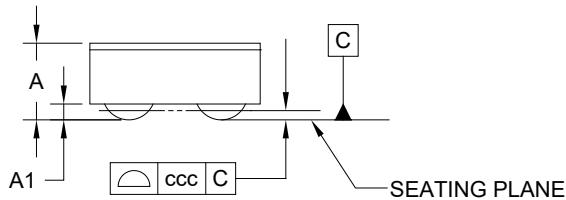
PACKAGE OUTLINE DIMENSIONS

WLCSP-0.64x0.64-4B-A



TOP VIEW

RECOMMENDED LAND PATTERN (Unit: mm)



SIDE VIEW

BOTTOM VIEW

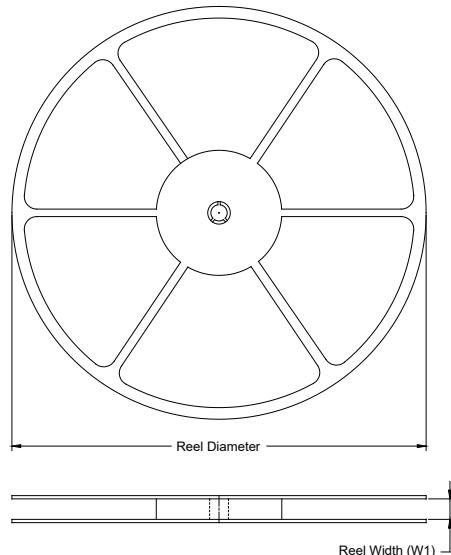
Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	-	-	0.318
A1	0.050	-	0.070
D	0.615	-	0.675
E	0.615	-	0.675
d	0.170	-	0.230
e	0.350 BSC		
ccc	0.050		

NOTE: This drawing is subject to change without notice.

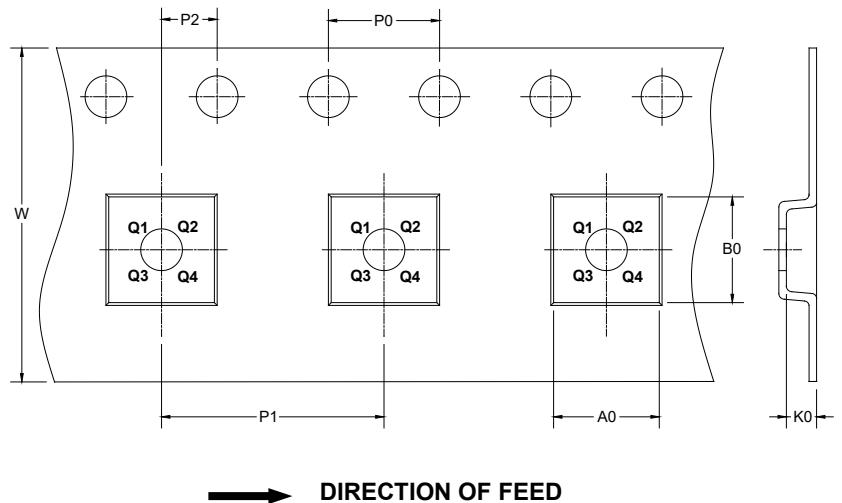
PACKAGE INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

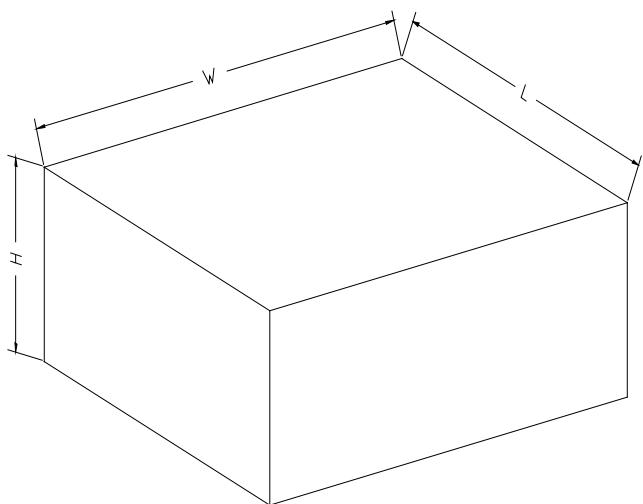
KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
XTDFN-1x1-4L	7"	9.5	1.16	1.16	0.50	4.0	2.0	2.0	8.0	Q1
WLCSP-0.64x0.64-4B-A	7"	9.5	0.74	0.74	0.37	4.0	3.0	2.0	8.0	Q1

DD0001

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18

DD0002